

FIG. 1
(PRIOR ART)

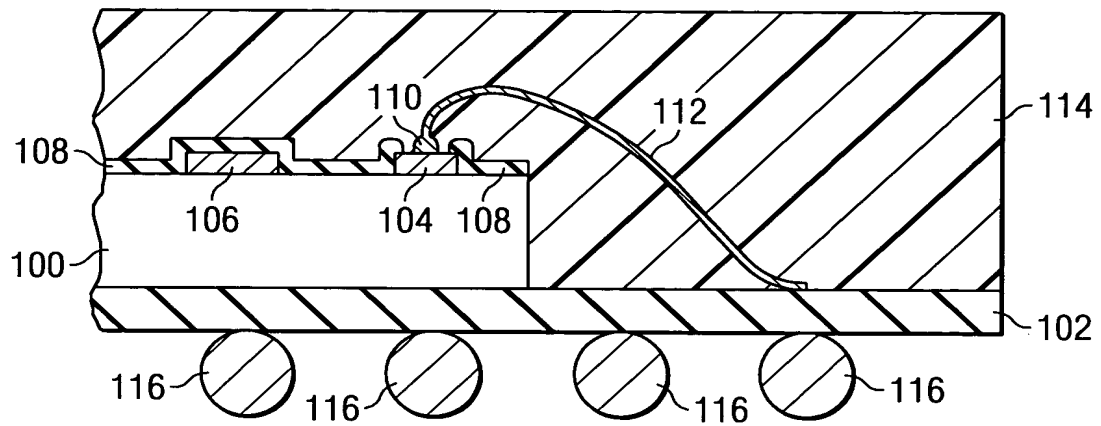


FIG. 2

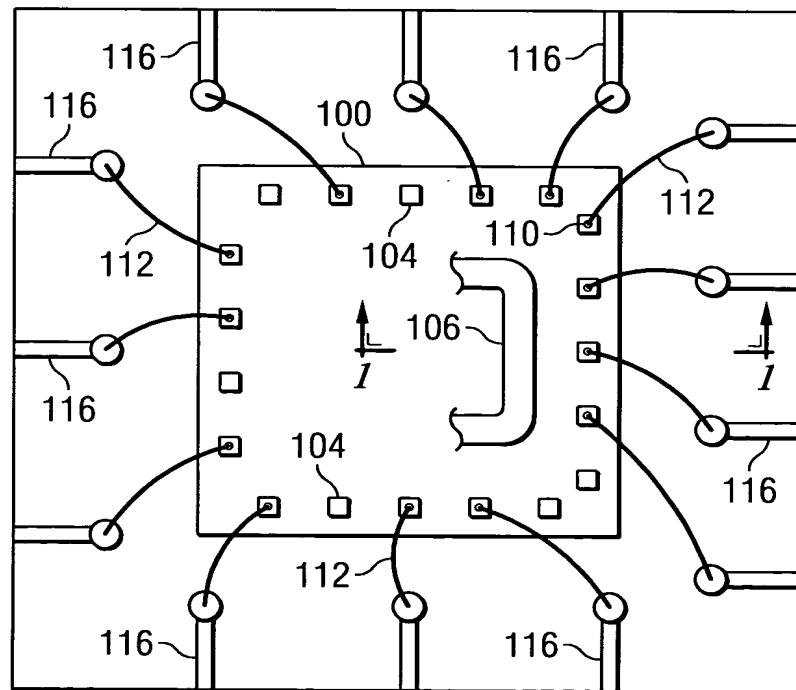


FIG. 3a
(PRIOR ART)

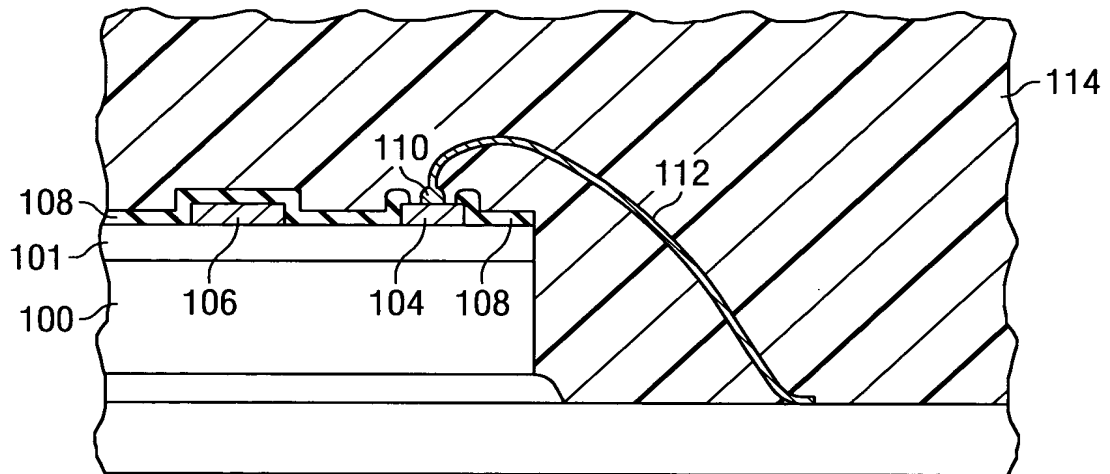


FIG. 3b
(PRIOR ART)

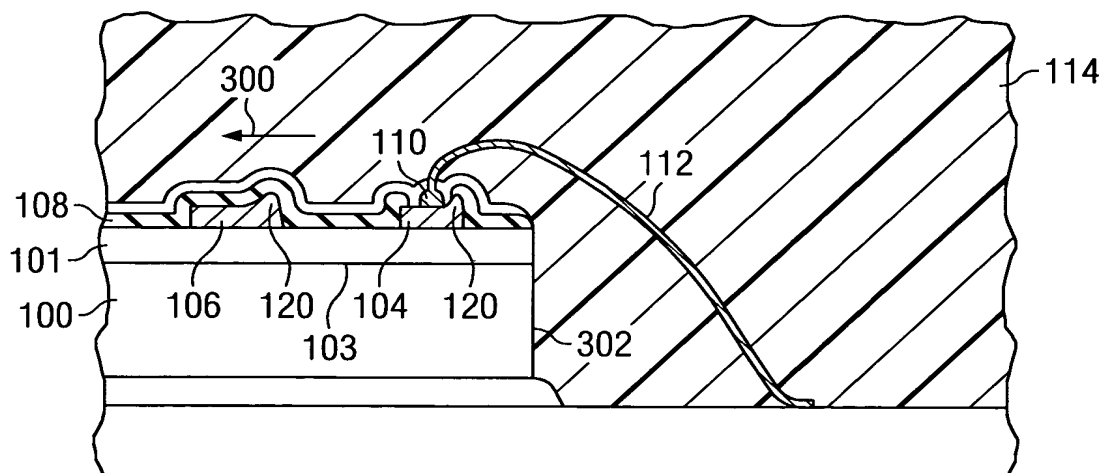


FIG. 3c
(PRIOR ART)

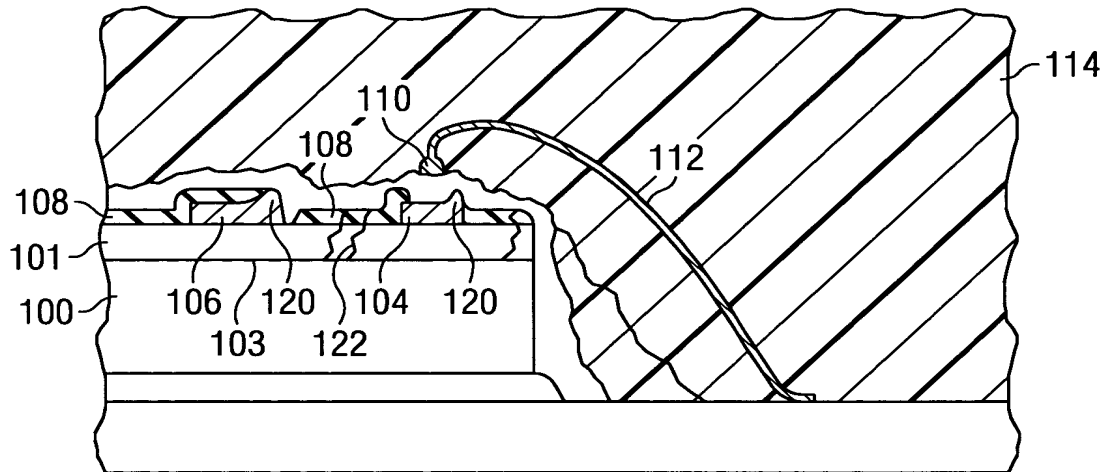


FIG. 4
(PRIOR ART)

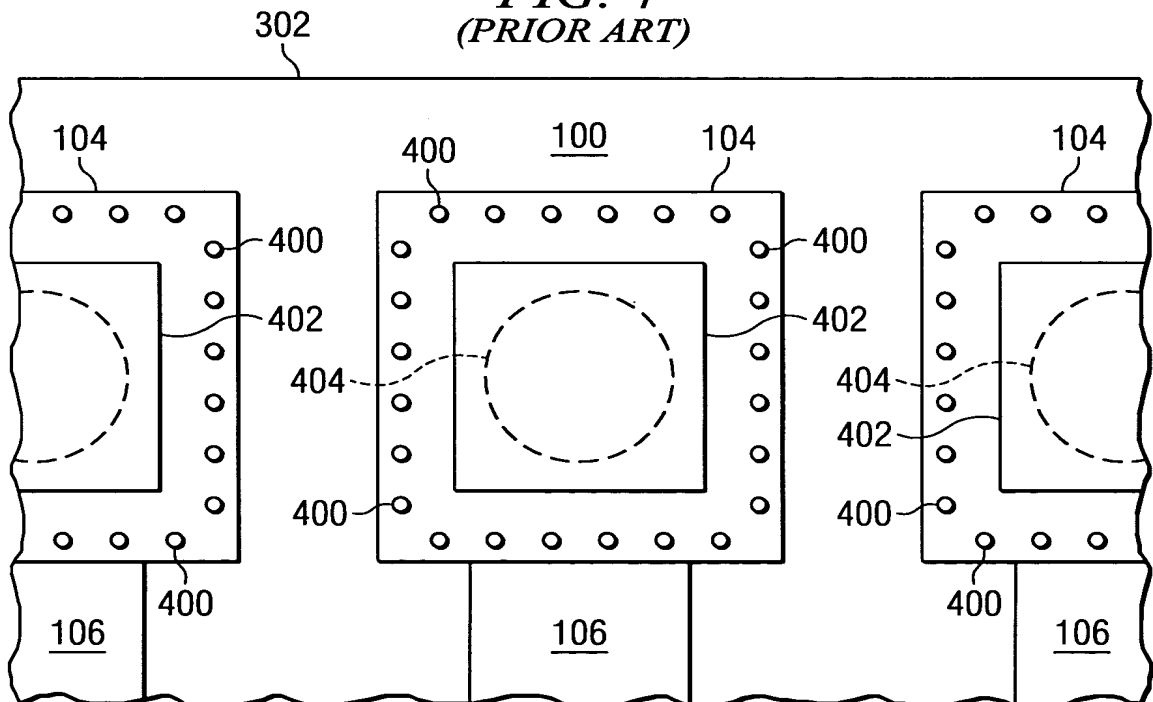


FIG. 5a

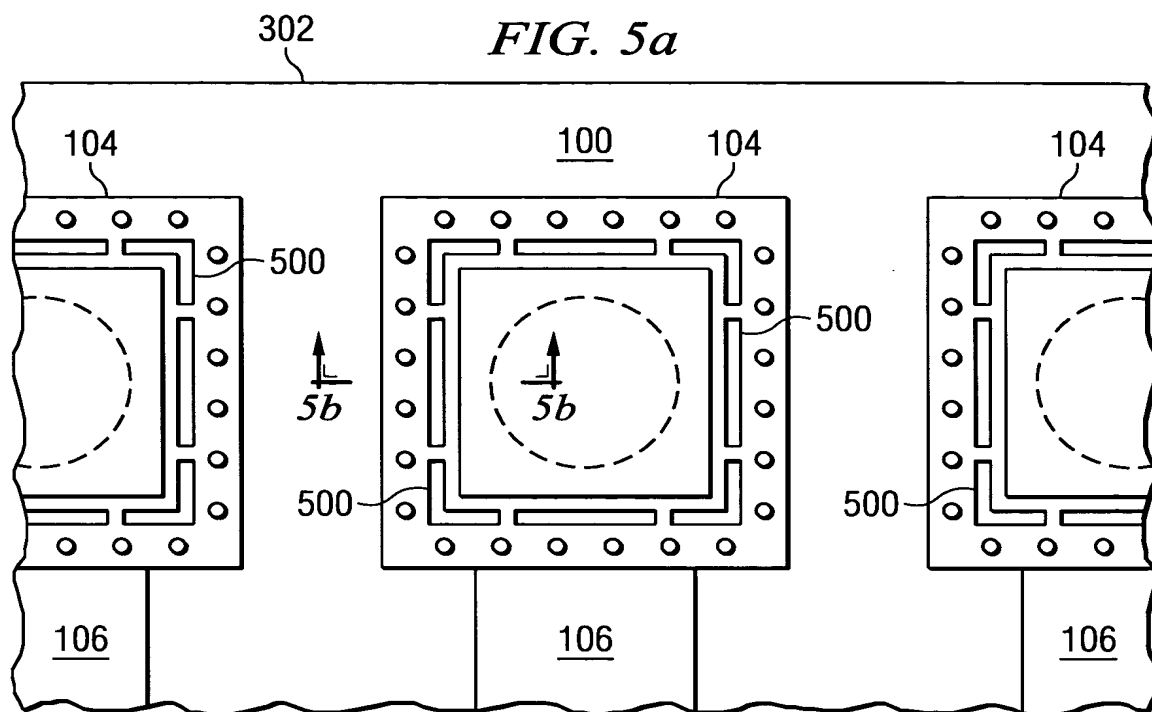
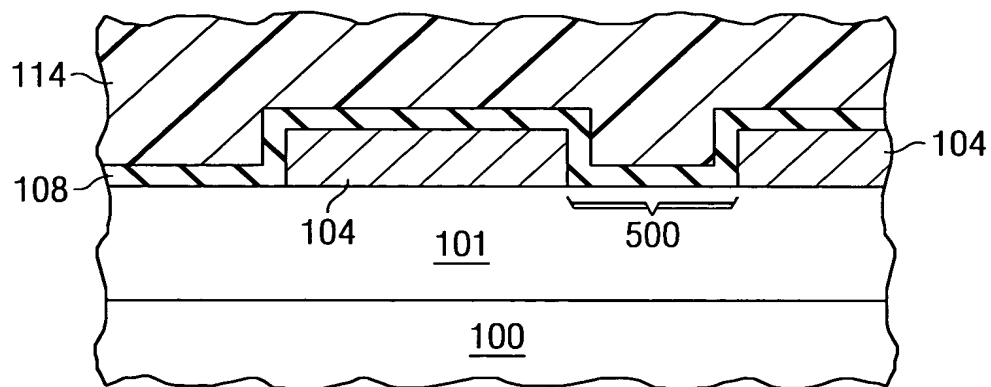
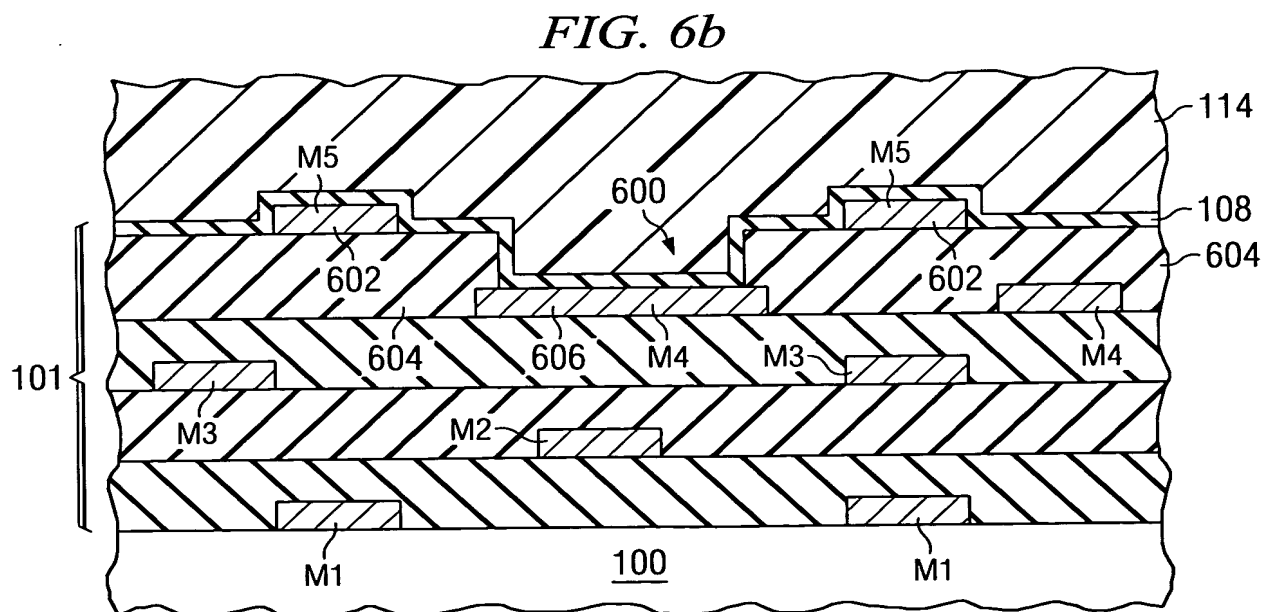
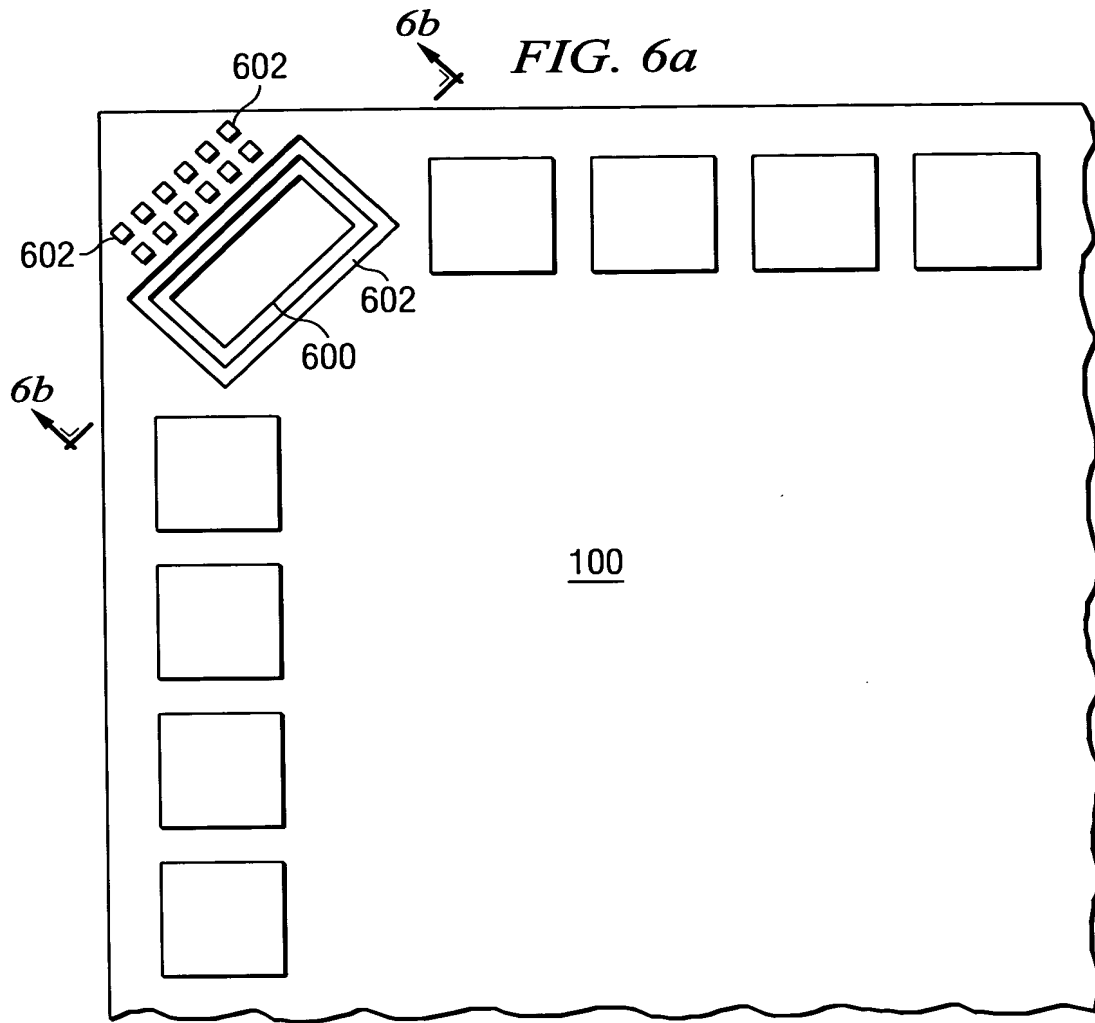


FIG. 5b



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FIG. 7a

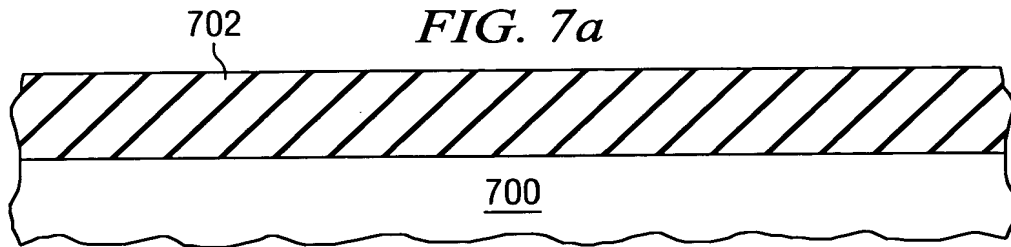


FIG. 7b

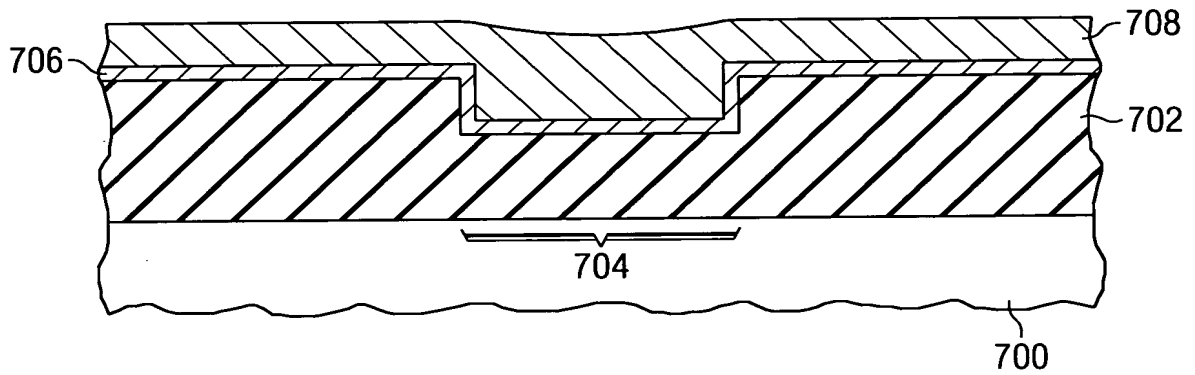


FIG. 7c

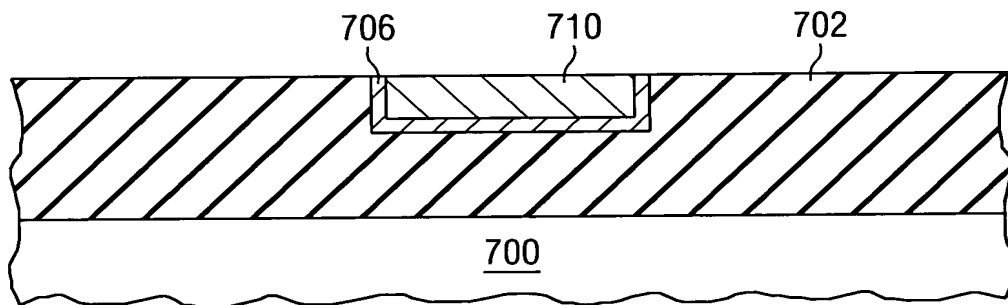
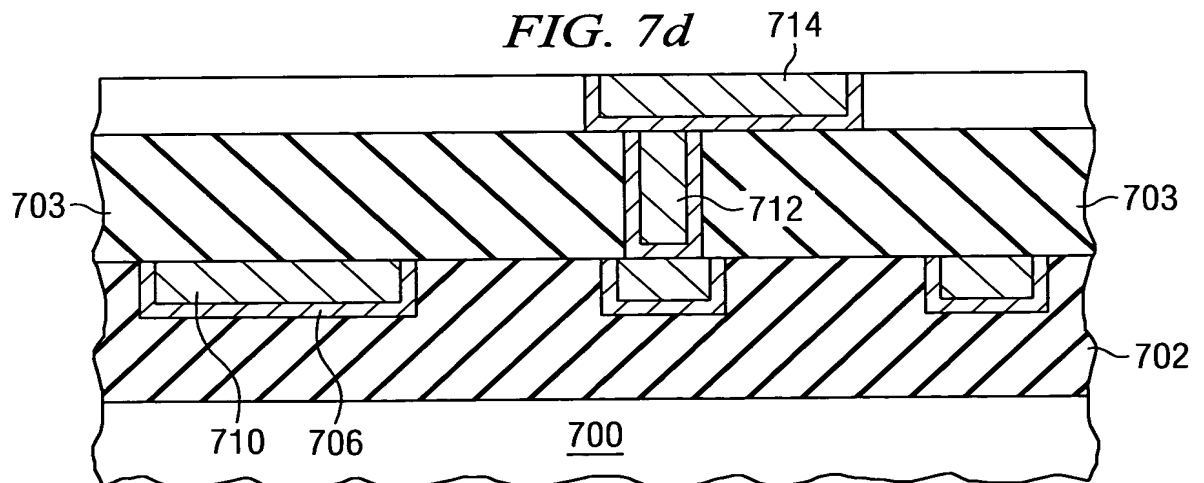


FIG. 7d



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FIG. 7e

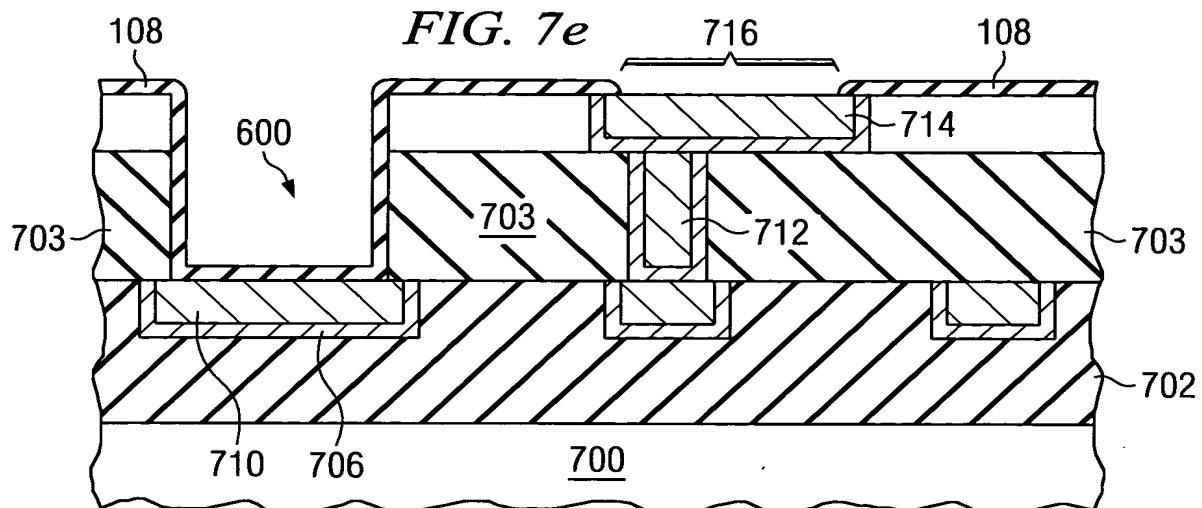


FIG. 7f

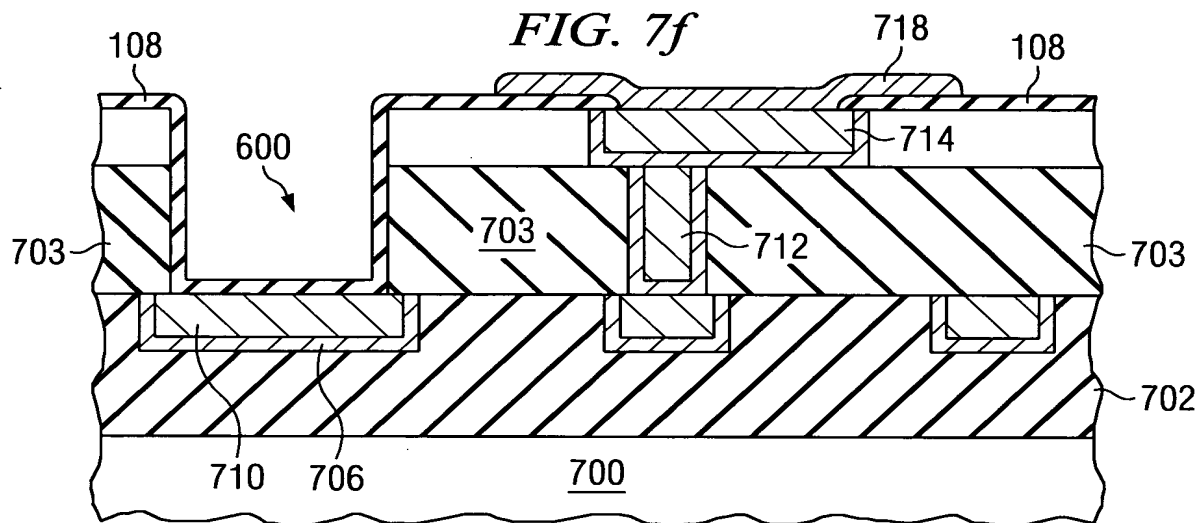
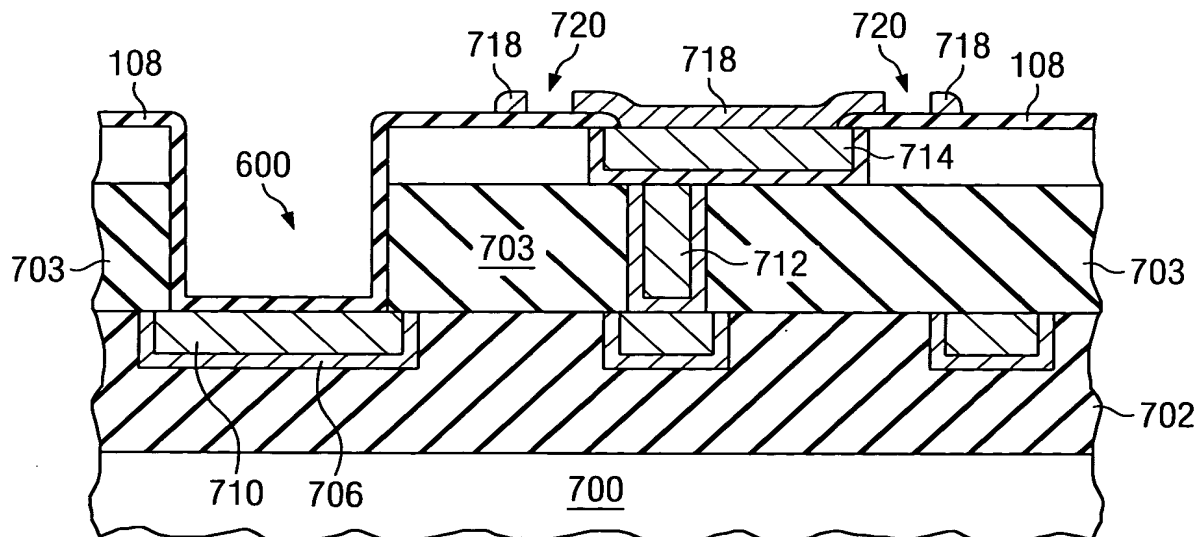


FIG. 7g



[illegible]

FIG. 8a is a cross-sectional view of a device. It shows a central layer 803 with a central opening 814. The opening is defined by a top layer 716 and a bottom layer 814. The device is surrounded by a material 830. A layer 108 is shown on the left side of the central layer 803.

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FIG. 8b

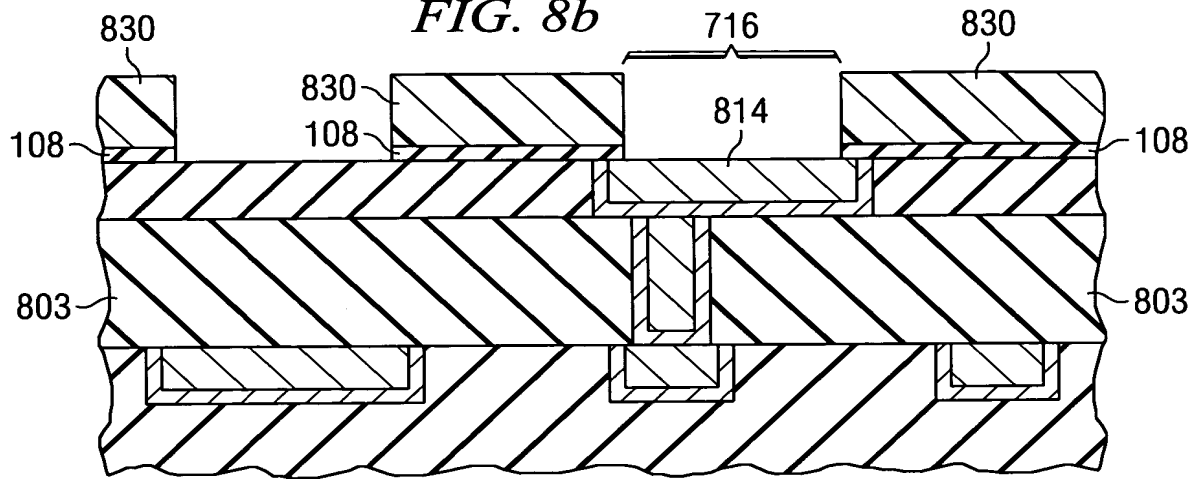


FIG. 8c

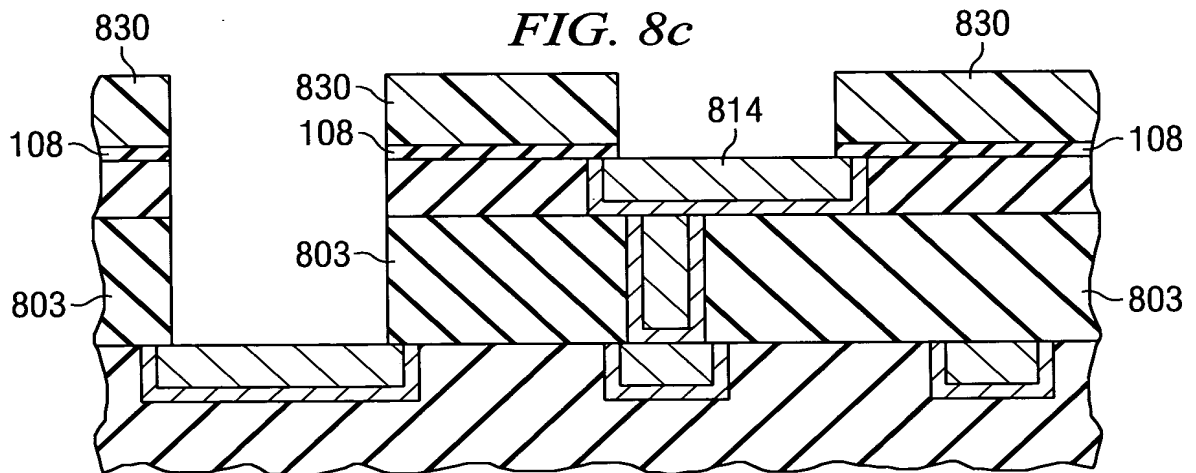


FIG. 8d

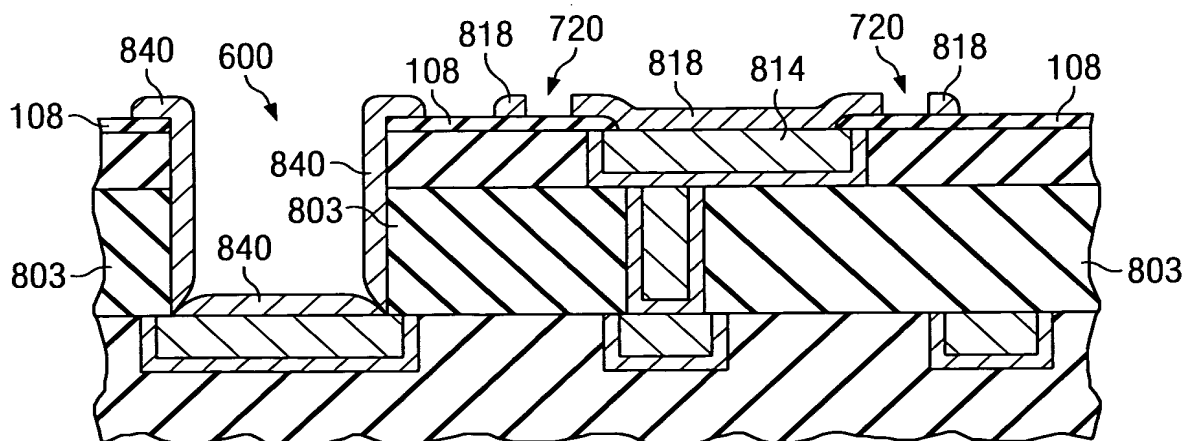


FIG. 9a

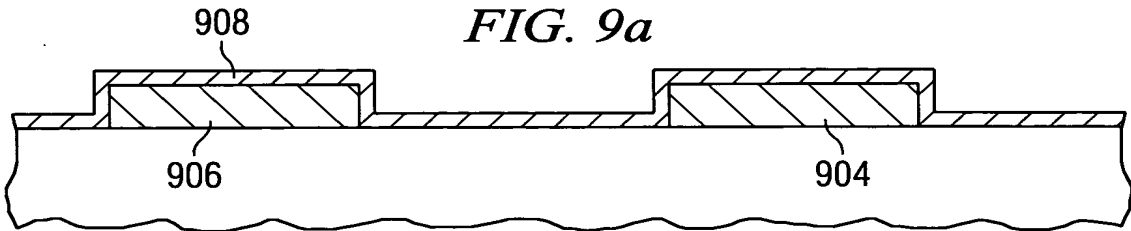


FIG. 9b

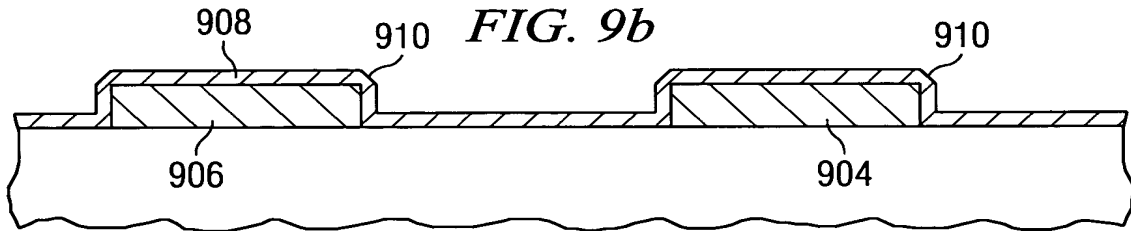


FIG. 9c

